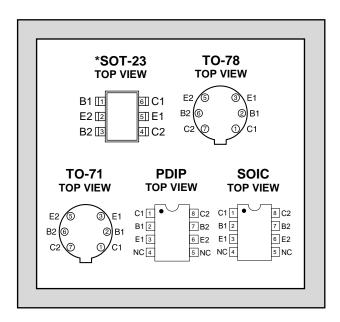


Twenty-Five Years Of Quality Through Innovation

*FEATURES								
6 LEAD SOT-23 SURFACE MOUNT PACKAGE*								
TIGHT MATCHING ¹ 2mV								
EXCELLENT THERMAL TRACKING ¹	3μV/°C							
ABSOLUTE MAXIMUM RATINGS ²								
@ 25 °C (unless otherwise stated)								
Maximum Temperatures								
Storage Temperature	-55 to +150 °C							
Operating Junction Temperature	-55 to +150 °C							
Maximum Power Dissipation								
Continuous Power Dissipation TBD								
Maximum Currents								
Collector Current 50mA								
Maximum Voltages								
Collector to Collector Voltage 50V								

LS3250 SERIES

MONOLITHIC DUAL NPN TRANSISTORS



MATCHING ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

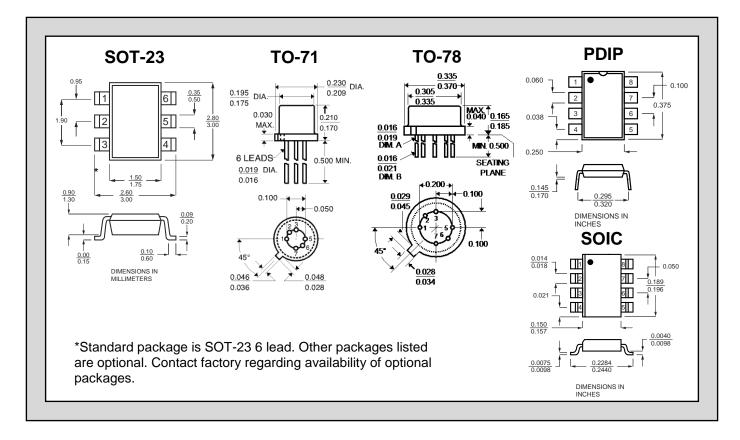
SYMBOL	CHARACTERISTIC	LS3250A		LS3250B		LS3250C		UNIT	CONDITIONS
		MIN	MAX	MIN	MAX	MIN	MAX	ONII	CONDITIONS
$\left V_{BE1}-V_{BE2}\right $	Base to Emitter Voltage Differential		2		5		10	mV	$I_C = 10\mu A$, $V_{CE} = 5V$
$\frac{\left V_{\text{BE1}}-V_{\text{BE2}}\right }{\Delta T}$	Base to Emitter Voltage Differential Change with Temperature		3		5		15	μV/°C	$I_C = 10\mu A$, $V_{CE} = 5V$ $T_A = -40^{\circ}C$ to $+85^{\circ}C$
I _{B1} — I _{B2}	Base Current Differential		10		10		10	nA	$I_C=10\mu A,V_{CE}=5V$
$\frac{\left I_{B1}-I_{B2}\right }{\Delta T}$	Base Current Differential Change with Temperature		0.5		0.5		1.0	nA/°C	$I_C = 10\mu A$, $V_{CE} = 5V$ $T_A = -40^{\circ}C$ to $+85^{\circ}C$
h _{FE1} /h _{FE2}	Current Gain Differential		10		10		15	%	Ic = 1mA, VcE = 5V

ELECTRICAL CHARACTERISTICS @25 °C (unless otherwise stated)

SYMBOL	CHARACTERISTIC	LS3250A		LS3250B		LS3250C		UNIT	CONDITIONS
		MIN	MAX	MIN	MAX	MIN	MAX	UNIT	CONDITIONS
BV _{CBO}	Collector to Base Breakdown Voltage	45		40		20			$I_C = 10\mu A$, $I_E = 0A$
BV _{CEO}	Collector to Emitter Breakdown Voltage	45		40		20			$I_C = 10 \text{mA}, I_B = 0$
BV _{CCO}	Collector to Collector Breakdown Voltage	±50		±50		±50		V	$I_C = \pm 1 \mu A, I_E = I_B = 0 A$
BV _{EBO}	Emitter to Base Breakdown Voltage ³	6.0		6.0		6.0			$I_E = 10\mu A, I_C = 0A$
V _{CE(SAT)}	Collector to Emitter Saturation Voltage		0.35		0.35		1.2		$I_C = 10mA$, $I_B = 1mA$

ELECTRICAL CHARACTERISTICS CONT. @25 °C (unless otherwise stated)

SYMBOL	CHARACTERISTIC	LS3250A		LS3250B		LS3250C		UNIT	CONDITIONS
		MIN	MAX	MIN	MAX	MIN	MAX	UNII	CONDITIONS
	DC Current Gain	150		100		50			$I_C = 1 \text{mA}, V_{CE} = 5 \text{V}$
h _{FE}		150	650	80		40			$I_C = 10$ mA, $V_{CE} = 5$ V
		125		60		30			$I_C = 35mA$, $V_{CE} = 5V$
lone	Collector Cutoff Current		0.35		0.35				$I_E = 0A, V_{CB} = 30V$
I _{CBO}							0.2	nA	$I_E = 0A$, $V_{CB} = 20V$
I _{EBO}	Emitter Cutoff Current		0.35		0.35		0.35		$I_E = 0A$, $V_{CB} = 3V$
I _{C1C2}	Collector to Collector Leakage Current		±1		±1		±1	μΑ	$V_{CC} = \pm 50V, I_E = I_B = 0A$
Сово	Output Capacitance		2		2		2	pF	$I_E = 0A$, $V_{CB} = 10V$
f⊤	Gain Bandwidth Product (Current)		600		600		600	MHz	$I_C = 1 \text{mA}, V_{CE} = 5 \text{V}$
NF	Noise Figure (Narrow Band)		3		3		3	dB	$I_C = 100\mu A$, $V_{CE} = 5V$ BW = 200Hz $R_B = 10\Omega$, $f = 1kHz$



NOTES

- 1. Maximum rating for LS3250A, SOT23-6.
- 2. Absolute maximum ratings are limiting values above which serviceability may be impaired.
- 3. The reverse Base to Emitter voltage must never exceed 6.0 Volts. The reverse Base to Emitter current must never exceed 10µA. Information furnished by Linear Integrated Systems is believed to be accurate and reliable. However, no responsibility is assumed for its use; nor for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Linear Integrated Systems.

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